



RoHS Compliant



MDWC12D025ERH

Common-Drain Dual N-Channel Trench MOSFET 12V, 2.55 mΩ

General Description

The MDWC12D025ERH uses advanced Magnachip's MOSFET Technology, which provides high performance in on-state resistance and excellent reliability. Excellent low $R_{SS(ON)}$, low gate charge operation and operation for Battery Application.

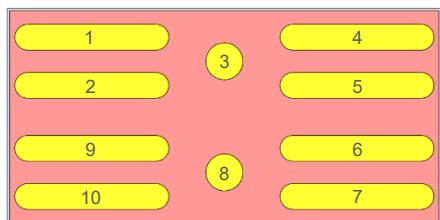
Features

- $V_{SS} = 12V$
- Source-Source ON Resistance;
 $R_{SS(ON)} < 2.30m\Omega$ @ $V_{GS} = 4.5V$
 $R_{SS(ON)} < 2.55m\Omega$ @ $V_{GS} = 3.8V$
 $R_{SS(ON)} < 3.75m\Omega$ @ $V_{GS} = 3.1V$
 $R_{SS(ON)} < 5.80m\Omega$ @ $V_{GS} = 2.5V$

Applications

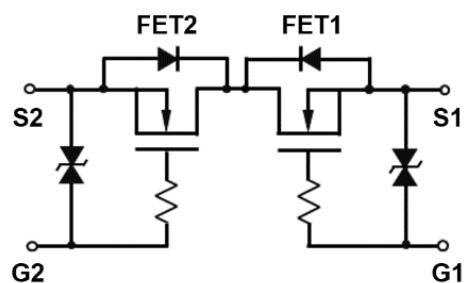
- Portable Battery Protection

Bottom View



2.98mm x 1.49mm WLCSP

Equivalent circuit



1, 2, 4, 5 : Source1(FET1) 3 : Gate1(FET1)
6, 7, 9, 10 : Source2(FET2) 8 : Gate2(FET2)

Absolute Maximum Ratings

Characteristics	Symbol	Rating	Units
Source-Source Voltage	V_{SSS}	12	V
Gate-Source Voltage	V_{GSS}	± 8	V
Source Current	I_S	23.2	A
	I_{SP}	92.8	A
Total Power Dissipation	P_D	2.2	W
Channel Temperature	T_{ch}	-55~150	°C
Junction and Storage Temperature Range	T_J, T_{stg}	-55~150	°C

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance ¹	$R_{θJA}$	65	°C/W

Ordering Information

Part Number	Temp. Range	Package	Packing	RoHS Status
MDWC12D025ERH	-55~150 °C	WLCSP	Tape and Reel	Halogen Free

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Units
Static Characteristics						
Source-Source Breakdown Voltage	BV_{SSS}	$I_S = 250\mu\text{A}, V_{GS} = 0\text{V}$	12	-	-	V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{SS} = V_{GS}, I_S = 250\mu\text{A}$	0.4	0.85	1.3	
Cut-Off Current	I_{SSS}	$V_{SS} = 12\text{V}, V_{GS} = 0\text{V}$	-	-	1	μA
Gate Leakage Current	$I_{GSS\ 1}$	$V_{GS} = \pm 8\text{V}, V_{SS} = 0\text{V}$	-	-	10	μA
	$I_{GSS\ 2}$	$V_{GS} = \pm 5\text{V}, V_{SS} = 0\text{V}$	-	-	1	
Source-Source Resistance	$R_{SS(\text{ON})}$	$V_{GS} = 4.5\text{V}, I_S = 5.0\text{A}$	-	1.75	2.30	
		$V_{GS} = 3.8\text{V}, I_S = 5.0\text{A}$	-	1.95	2.55	
		$V_{GS} = 3.1\text{V}, I_S = 5.0\text{A}$	-	2.25	3.75	
		$V_{GS} = 2.5\text{V}, I_S = 5.0\text{A}$	-	2.90	5.80	
Dynamic Characteristics						
Total Gate Charge	Q_g	$V_{DD} = 6\text{V}, I_S = 5.0\text{A}, V_{GS} = 3.8\text{V}$	-	25.1	-	
Gate-Source Charge	Q_{gs}		-	4.3	-	nC
Gate-Drain Charge	Q_{gd}		-	10.4	-	
Input Capacitance	C_{iss}	$V_{SS} = 6\text{V}, V_{GS} = 0\text{V}, f = 50\text{kHz}$	-	3,496	-	
Reverse Transfer Capacitance	C_{rss}		-	872	-	pF
Output Capacitance	C_{oss}		-	1,080	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 3.8\text{V}, V_{DD} = 6\text{V}, I_S = 5.0\text{A}, R_{\text{GEN}} = 3\Omega$	-	0.02	-	
Rise Time	t_r		-	0.25	-	
Turn-Off Delay Time	$t_{d(off)}$		-	5.54	-	μs
Fall Time	t_f		-	14.64	-	
Drain-Source Body Diode Characteristics						
Source-Source Diode Forward Voltage	$VF_{(S-S)}$	$I_F = 5\text{A}, V_{GS} = 0\text{V}$	-	0.75	1.2	V

Note *1. Test on PCB board (60.0mm x 24.0mm x 1.0t)

Characteristic Graph

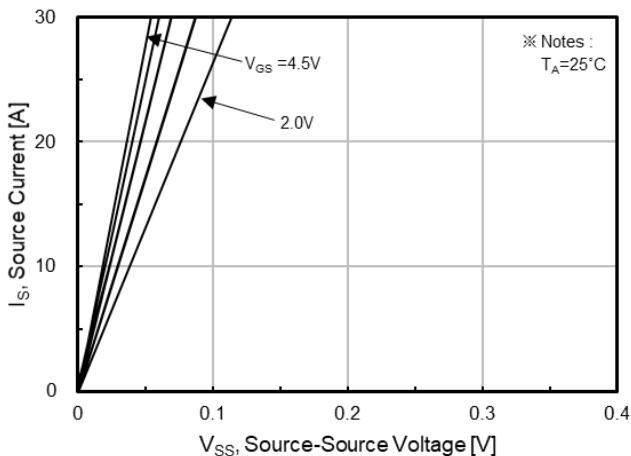


Fig.1 On-Region Characteristics

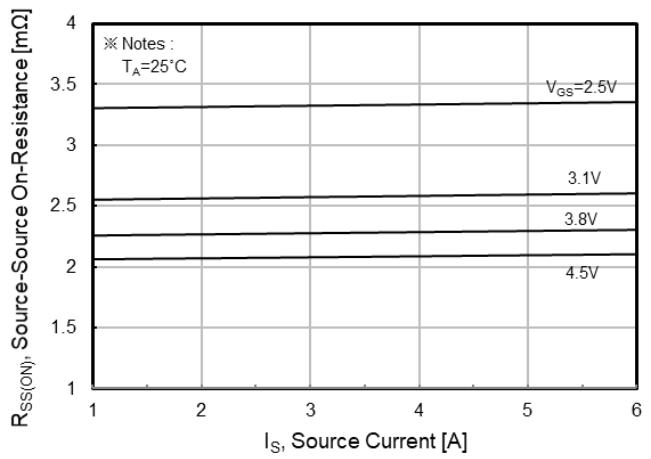


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

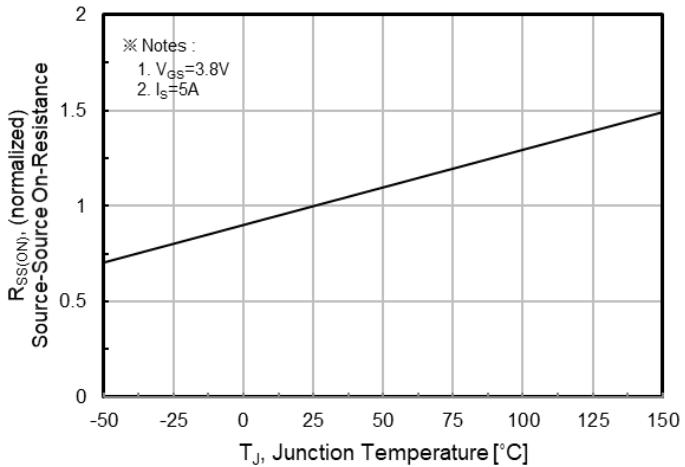


Fig.3 On-Resistance Variation with Temperature

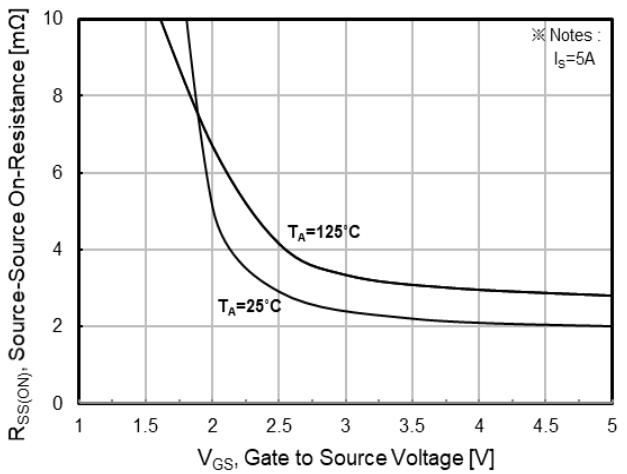


Fig.4 On-Resistance Variation with Gate to Source Voltage

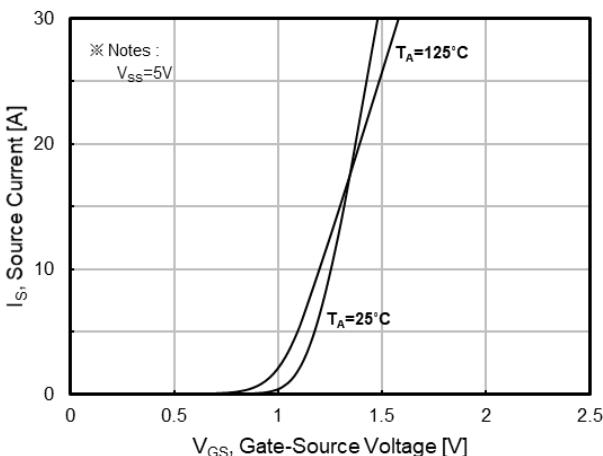


Fig.5 Transfer Characteristics

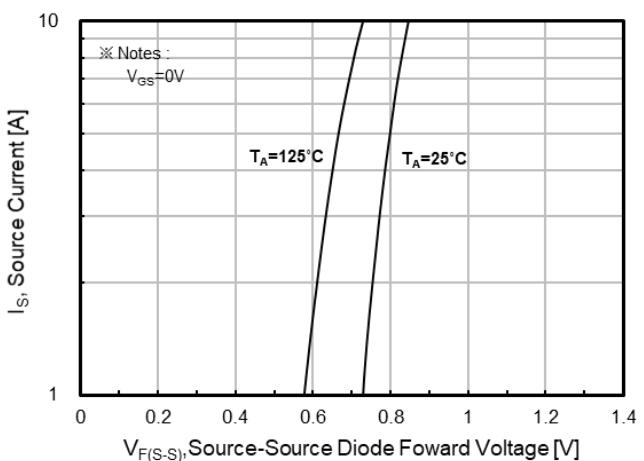


Fig.6 Forward Source to Source Characteristics

Characteristic Graph

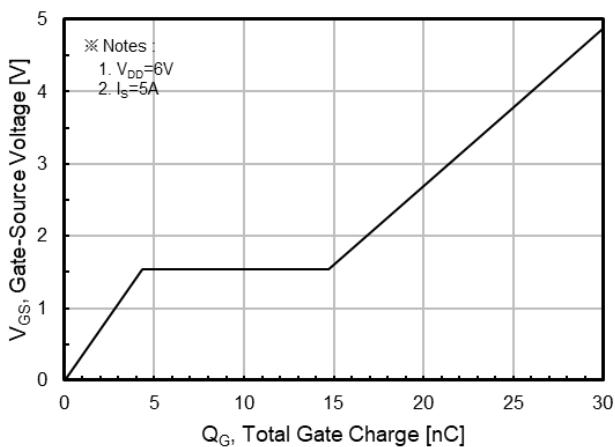


Fig.7 Gate Charge Characteristics

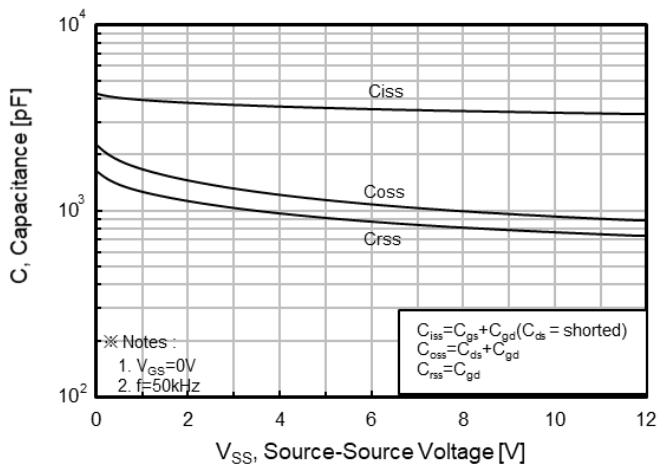


Fig.8 Capacitance Characteristics

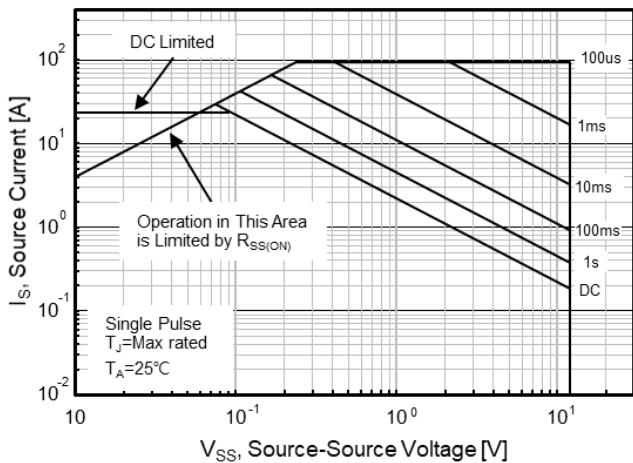


Fig.9 Maximum Safe Operating Area

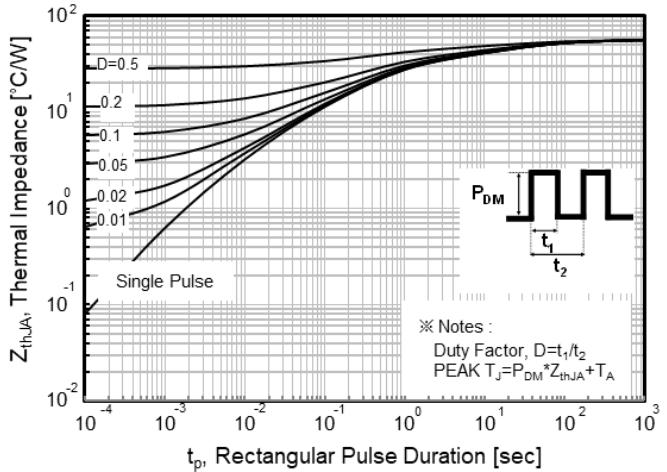
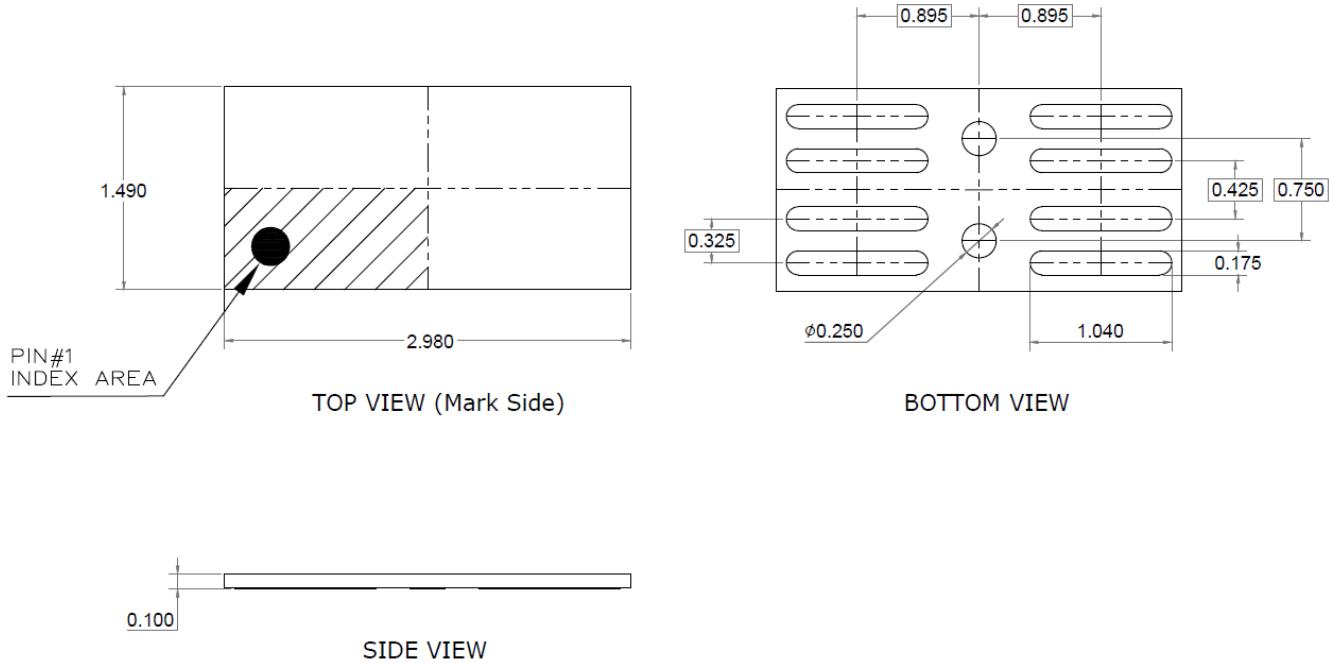


Fig.10 Transient Thermal Response Curve

PACKAGE OUTLINE



NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. GENERAL TOLERANCE : $\pm 0.03\text{mm}$
3. PACKAGE BODY SIZES EXCLUDE FLASH & BURRS

DISCLAIMER:

The Products are not designed for use in hostile environments, including, without limitation, aircraft, nuclear power generation, medical appliances, and devices or systems in which malfunction of any Product can reasonably be expected to result in a personal injury. Seller's customers using or selling Seller's products for use in such applications do so at their own risk and agree to fully defend and indemnify Seller.

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